

Product data sheet

1. General description

Planar passivated very sensitive gate four quadrant triac in a SOT223 (SC-73) surface-mountable plastic package intended for applications requiring enhanced immunity to noise and direct interfacing to logic level ICs and low power gate drivers.

2. Features and benefits

- · Direct interfacing to logic level ICs
- · Enhanced current surge capability
- Enhanced noise immunity
- High blocking voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Surface-mountable package
- Triggering in all four quadrants
- Very sensitive gate

3. Applications

- · General purpose low power motor control
- Home appliances
- Industrial process control
- Low power AC Fan controllers

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Notes		Values		Unit
Absolute	maximum rating						
V_{DRM}	repetitive peak off-state voltage				800		V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{sp} ≤ 105 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>			1		A
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig. 4; Fig. 5		12.5 13.8		A	
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms				А	
Tj	junction temperature				125		°C
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ T _j = 25 °C; <u>Fig. 9</u>		0.3	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; Fig. 9		0.3	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G-};$ $\text{T}_{j} = 25 \text{ °C}; \text{ Fig. 9}$		0.3	-	5	mA
		V _D = 12 V; I _T = 0.1 A; T2- G+; T _j = 25 °C; <u>Fig. 9</u>		0.3	-	7	mA

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Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	Static characteristics						
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 11</u>		-	-	10	mA
V _T	on-state voltage	I _T = 1.4 A; T _j = 25 °C; <u>Fig. 12</u>		-	1.3	1.6	V
Dynamic	characteristics						
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; \text{ T}_{\text{j}} = 110 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit; Fig. 14$		100	-	-	V/µs
dV _{com} /dt	rate of change of commutating voltage	$V_D = 400 \text{ V}; \text{ T}_j = 110 \text{ °C};$ $dI_{com}/dt = 0.44 \text{ A/ms};$ gate open circuit		1	-	-	V/µs

5. Pinning information

Table 2. Pinn	ning information
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Pin	Symbol	Description	Simplified outline	Graphic symbol
1	T1	main terminal 1		Ν
2	T2	main terminal 2		
3	G	gate		sym051
4	T2	main terminal 2		

6. Ordering information

able 5. Ordering mornauon							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
Z0107NN0	SOT223	Z0107NN0,135	Reel	4000	SOT223	16-Mar-2006	

7. Marking

Table	4. Ma	rkina	codes

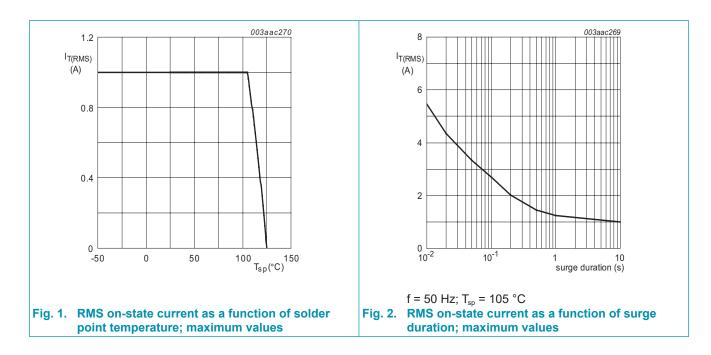
Type number	Marking codes		
	Assembly factory: L	Assembly factory: d	
Z0107NN0	JLxxx	Jdxxx	
	107NN0	107NN0	

8. Limiting values

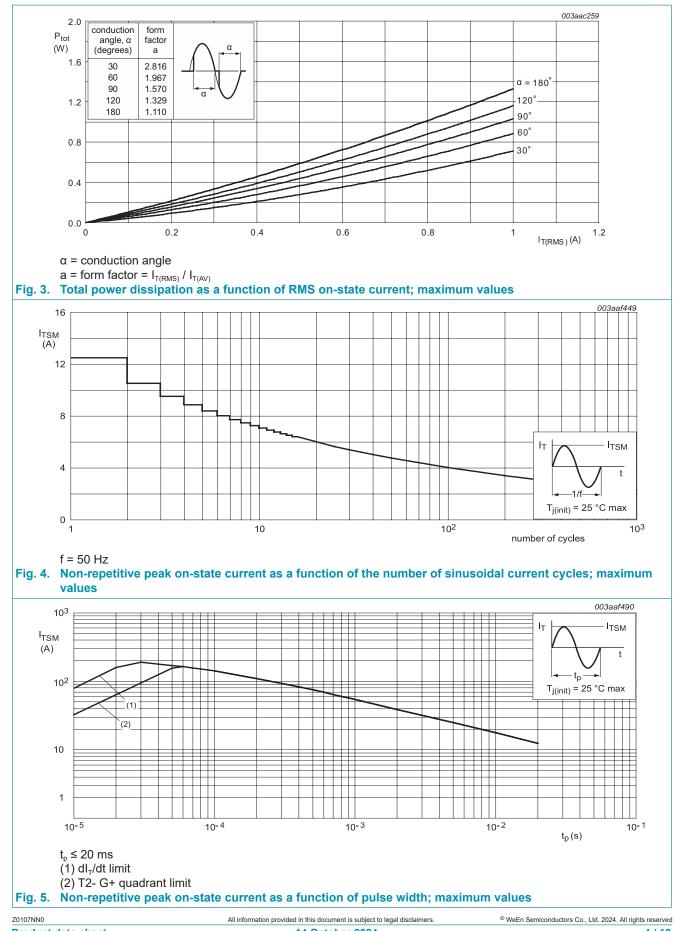
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V_{DRM}	repetitive peak off-state voltage			800	V
$\mathbf{I}_{\mathrm{T(RMS)}}$	RMS on-state current	full sine wave; T _{sp} ≤ 105 °C; <u>Fig 1; Fig 2; Fig 3</u>		1	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig 4; Fig 5		12.5	A
		full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms		13.8	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN		0.78	A ² s
dl _T /dt	rate of rise of on-state current	I _G = 20 mA; T2+ G+		50	A/µs
		I _G = 20 mA; T2+ G-		50	A/µs
		I _G = 20 mA; T2- G-		50	A/µs
		I _G = 20 mA; T2- G+		20	A/µs
I _{GM}	peak gate current			1	А
P_{GM}	peak gate power			2	W
$P_{G(AV)}$	average gate power	over any 20 ms period		0.1	W
T _{stg}	storage temperature			-40 to 150	°C
Tj	junction temperature			125	°C



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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point	full cycle; <u>Fig 6</u>		-	-	15	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	full cycle; printed circuit board mounted; minimum footprint; <u>Fig 7</u>		-	156	-	K/W
		full cycle; printed circuit board mounted; pad area; Fig 8		-	70	-	K/W

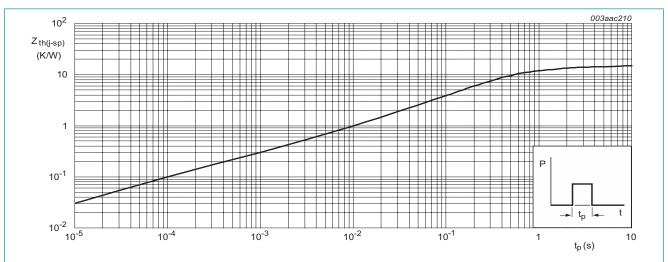
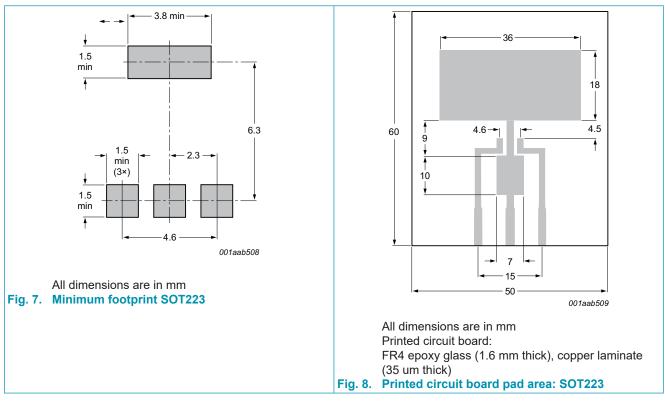


Fig. 6. Transient thermal impedance from junction to solder point as a function of pulse width

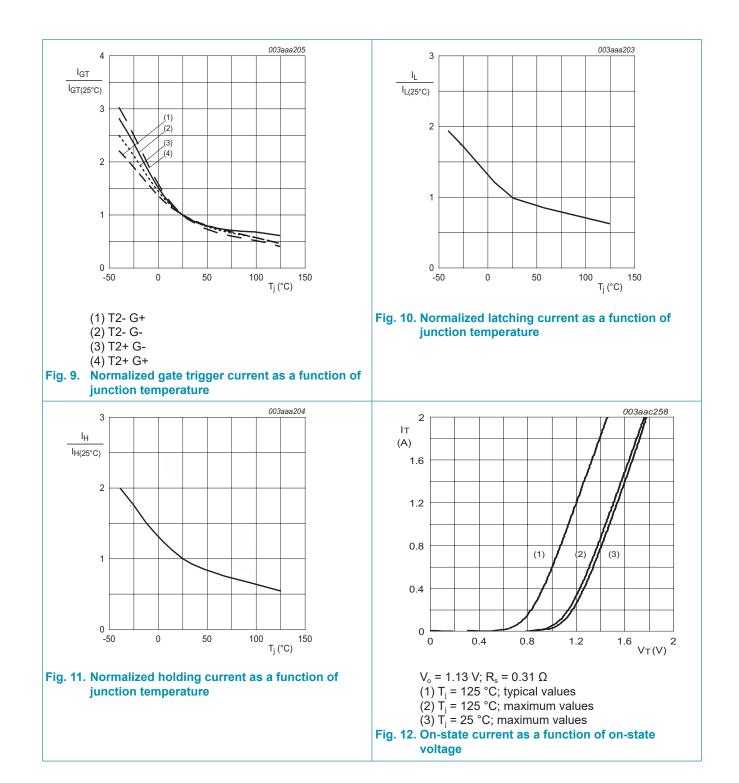


10. Characteristics

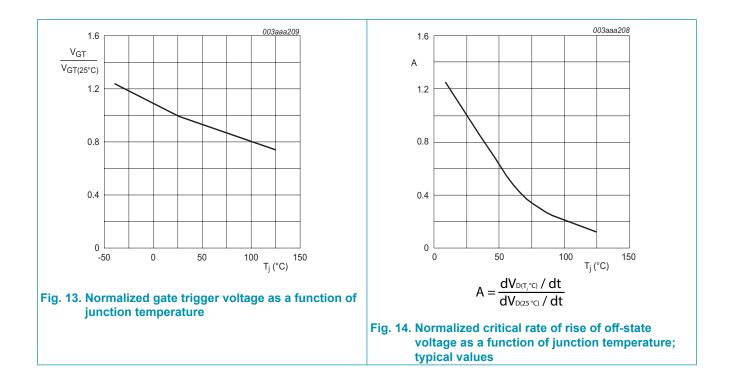
Table 7. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G+};$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 9}$		0.3	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2+ G-};$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 9}$		0.3	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G-};$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 9}$		0.3	-	5	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T2- G+};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 9}$		0.3	-	7	mA
I _L	latching current	$V_{D} = 12 \text{ V}; \text{ I}_{G} = 0.1 \text{ A}; \text{ T2+ G+};$ $\text{T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 10}$		-	-	10	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{G} = 0.1 \text{ A}; \text{ T2+ G-};$ T _j = 25 °C; Fig. 10		-	-	25	mA
		$V_{D} = 12 \text{ V}; \text{ I}_{G} = 0.1 \text{ A}; \text{ T2- G-};$ T _j = 25 °C; Fig. 10		-	-	10	mA
		V_{D} = 12 V; I _G = 0.1 A; T2- G+; T _j = 25 °C; Fig. 10		-	-	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 11</u>		-	-	10	mA
V _T	on-state voltage	I _T = 1.4 A; T _j = 25 °C; <u>Fig. 12</u>		-	1.3	1.6	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 13		-	-	1	V
		V _D = 800 V; I _T = 0.1 A; T _j = 125 °C; Fig. 13		0.2	-	-	V
I _D	off-state current	V _D = 800 V; T _j = 125 °C		-	-	0.5	mA
Dynamic	characteristics						
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 110 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 14		100	-	-	V/µs
dV _{com} /dt	rate of change of commutating voltage	$V_D = 400 \text{ V}; \text{ T}_j = 110 ^{\circ}\text{C};$ $dI_{com}/dt = 0.44 \text{ A/ms}; \text{ gate open circuit}$		1	-	-	V/µs

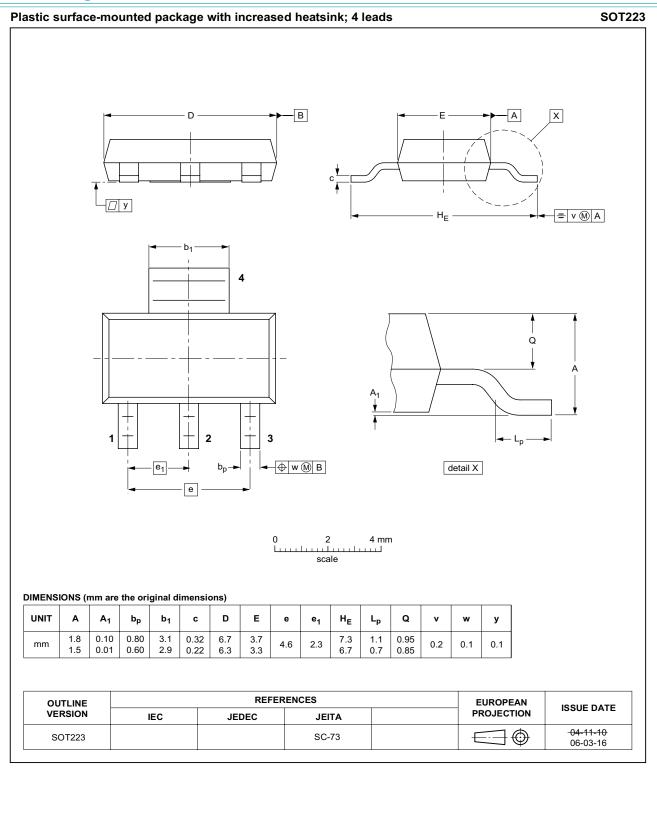
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11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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